



MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK
 SHELL: COPPER ALLOY OR SPCC, NICKEL PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATING ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 1 AMP MAX
 DIELECTRIC WITHSTANDING: 100V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 50m OHMS MAX
 INSULATION RESISTANCE: 100M OHMS MIN AT DC 100V
 OPERATION TEMPERATURE: -40°C~+85°C

PART NUMBER:
BUSMB - 0 5 * T * - 1 * 3

- SERIES
- NO. OF POS.
- CONTACT PLATED OPTION
- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 9: 30u" GOLD
- TIN PLATING ON SOLDER TAIL
- SHELL MATERIAL OPTION
- BLANK: COPPER ALLOY
- P: SPCC
- PACKAGE OPTION
- 2: TAPE REEL
- 3: TUBE

**P.C.B LAYOUT
 TOP VIEW ±0.05**

REV.	A	DRAWN BY	Zhong 2019/10/19	TITLE	MINI USB, B TYPE, PCB MOUNT, SMT, METAL SHIELD, FEMALE				
		APPROVED BY	Lion 2019/10/19	DRAW NO.	BUSMB-003	UNIT	MM	Sheet	1/1